Silicon P Channel Power MOS FET High Speed Power Switching

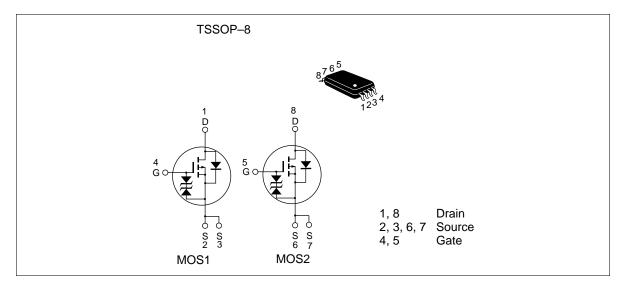
HITACHI

ADE-208-528D (Z) 5th. Edition December 1998

Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

Outline





Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	-20	V
Gate to source voltage	V _{GSS}	±10	V
Drain current	I _D	-2.5	А
Drain peak current	Note1 D(pulse)	-20	А
Body-drain diode reverse drain current	I _{DR}	-2.5	А
Channel dissipation	Pch Note2	1	W
Channel dissipation	Pch Note3	1.5	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Note: 1. $PW \le 10\mu s$, duty cycle $\le 1 \%$

2. 1 Drive operation ; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW≤ 10s

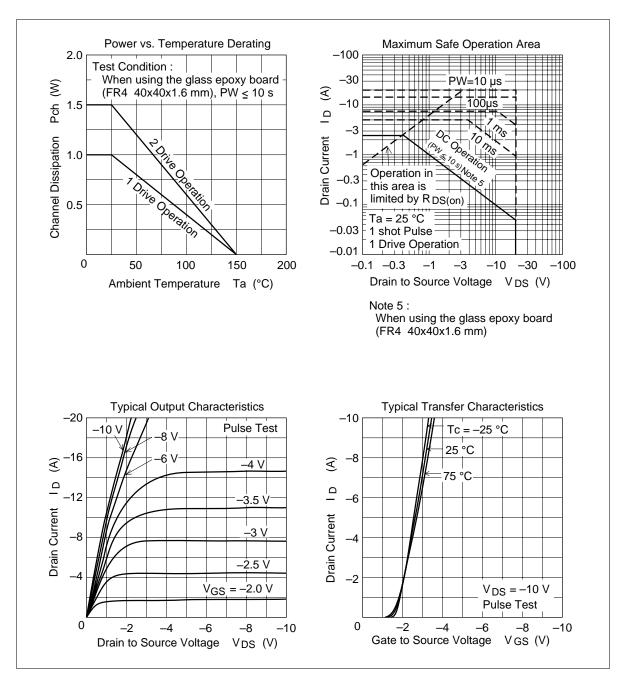
3. 2 Drive operation ; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10s

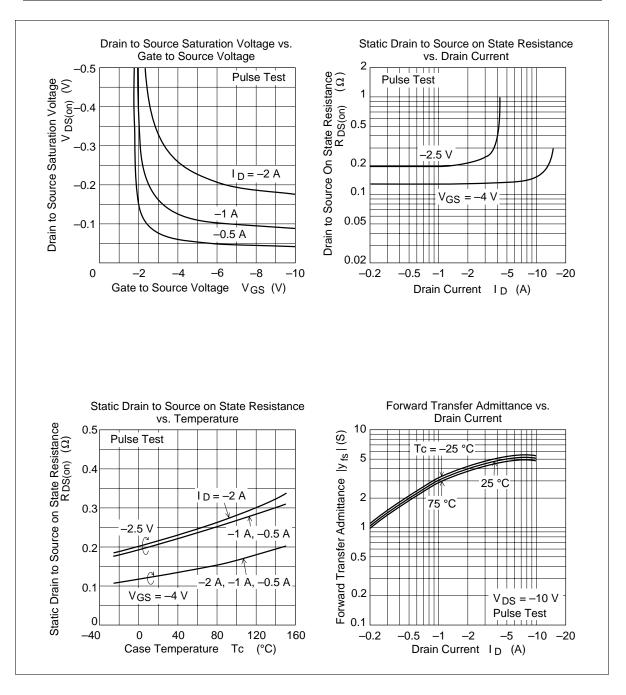
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-20	_		V	$I_{\rm D} = -10 {\rm mA}, V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±10	—	_	V	$I_{g} = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	_	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0$
Zero gate voltege drain current	I _{DSS}	—	—	-1	μA	$V_{\rm DS} = -20 \text{ V}, \text{ V}_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-0.5	—	-1.5	V	$V_{DS} = -10V, I_{D} = -1mA$
Static drain to source on state	$R_{DS(on)}$	—	0.13	0.16	Ω	$I_{\rm D} = -2A, V_{\rm GS} = -4V^{\rm Note4}$
resistance	$R_{\text{DS(on)}}$	—	0.21	0.28	Ω	$I_{\rm D} = -2A, V_{\rm GS} = -2.5V^{\rm Note4}$
Forward transfer admittance	y _{fs}	2.6	4	_	S	$I_{\rm D} = -2A, V_{\rm DS} = -10V^{\rm Note4}$
Input capacitance	Ciss	—	390	_	pF	$V_{DS} = -10V$
Output capacitance	Coss	—	200	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	70	_	pF	f = 1MHz
Turn-on delay time	t _{d(on)}	—	14	_	ns	$V_{GS} = -4V, I_{D} = -2A$
Rise time	t,	—	75	_	ns	$V_{DD} \approx -10V$
Turn-off delay time	$t_{d(off)}$	_	60	_	ns	_
Fall time	t _f	—	55	_	ns	_
Body-drain diode forward voltage	V_{DF}	—	-0.9	-1.17	V	$IF = -2.5A, V_{GS} = 0^{Note4}$
Body–drain diode reverse recovery time	t _{rr}	_	45		ns	IF = -2.5A, V _{GS} = 0 diF/ dt =20A/μs

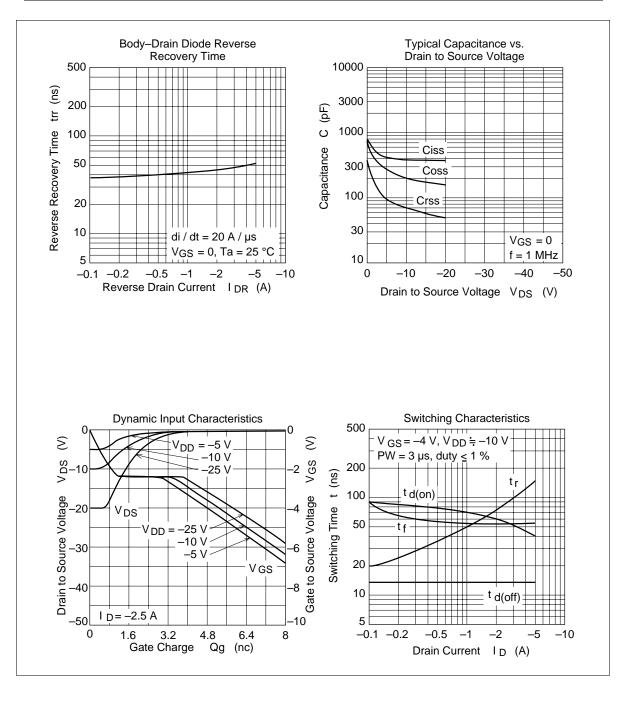
Electrical Characteristics (Ta = 25°C)

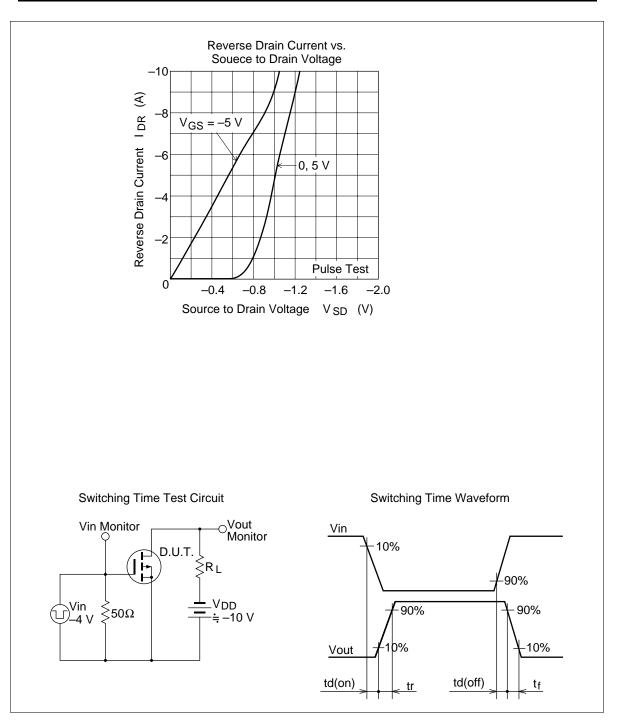
Note: 4. Pulse test

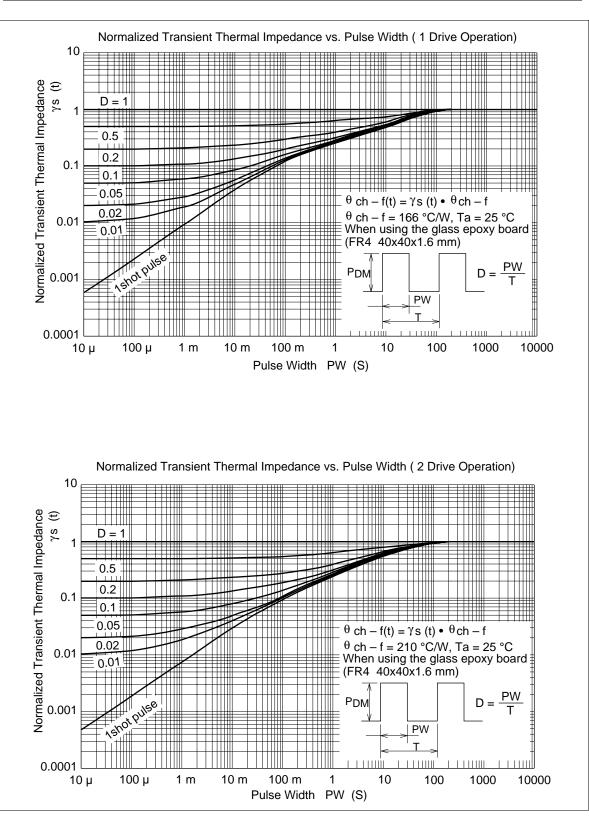
Main Characteristics











Package Dimentions

 3.00 ± 0.1 8 1111 5 4.40 ± 0.1 1 0000 4 10 Max 6.40 ± 0.20 चित्रम् 0 – 8 ° 0.65 $0.07^{\,+0.03}_{\,-0.04}$ 0.17 ± 0.05 0.50 ± 0.10 □ 0.10 0.22 +0.08 0.13 M Hitachi code TTP-8D EIAJ JEDEC

Unit: mm

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